

TIGER Pro

UNSW seminar:

**Latest TOPCon research progress in Jinko and
industrial innovation discussion**

About myself

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- ◆ PhD, The Australian National University
 - First-class honour, The University of New South Wales
- ◆ Member of International Electrotechnical Commission
- ◆ Jiangxi Province Thousand Talents Program
- ◆ Zhejiang Province Ten Thousand Talents Program

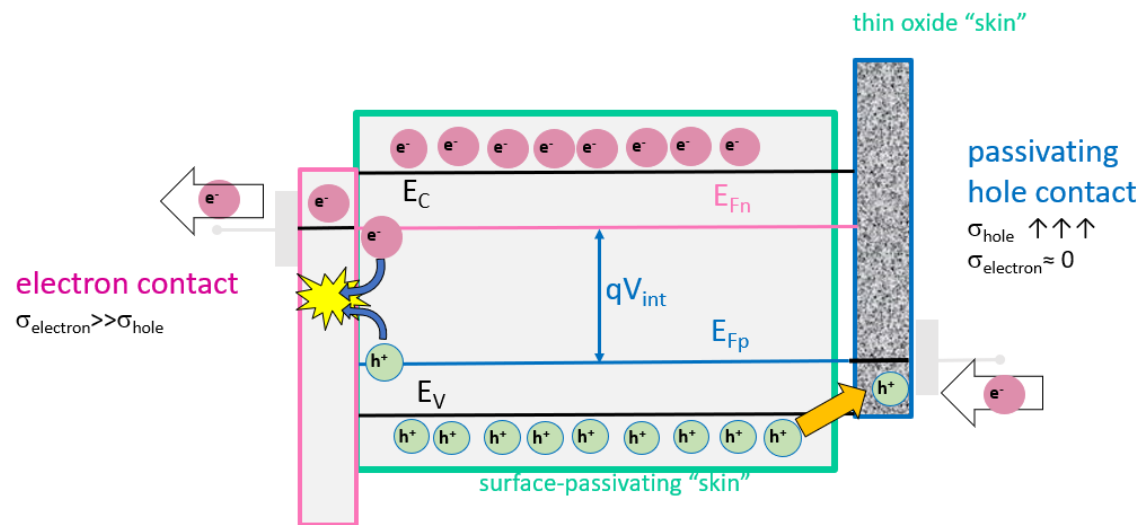
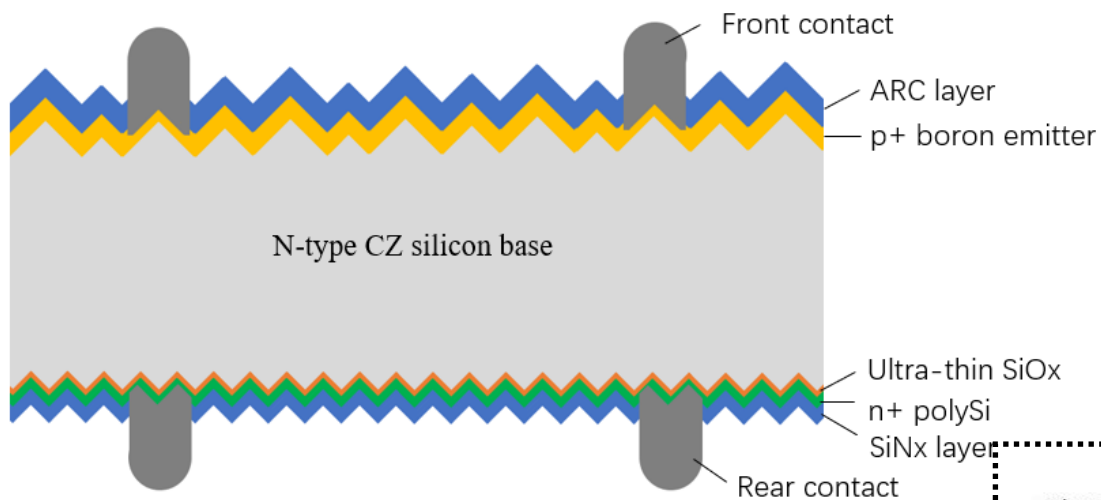


n-TOPCon research at Jinko Solar

Discussion about industrial innovation work

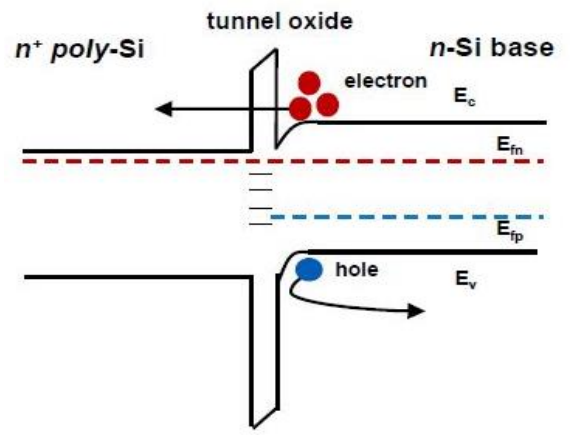
Hot topics in PV industry (questions welcome)

TOPCon Concept

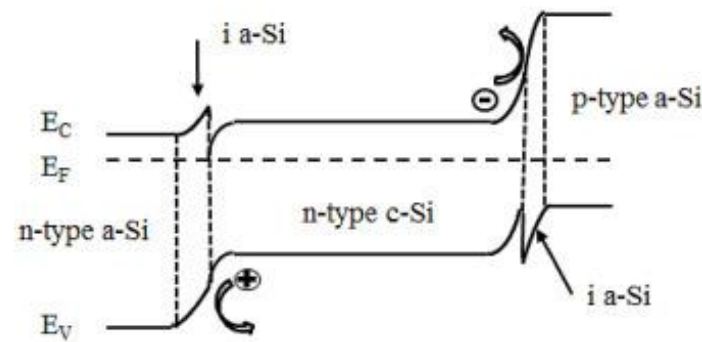


Key parameters

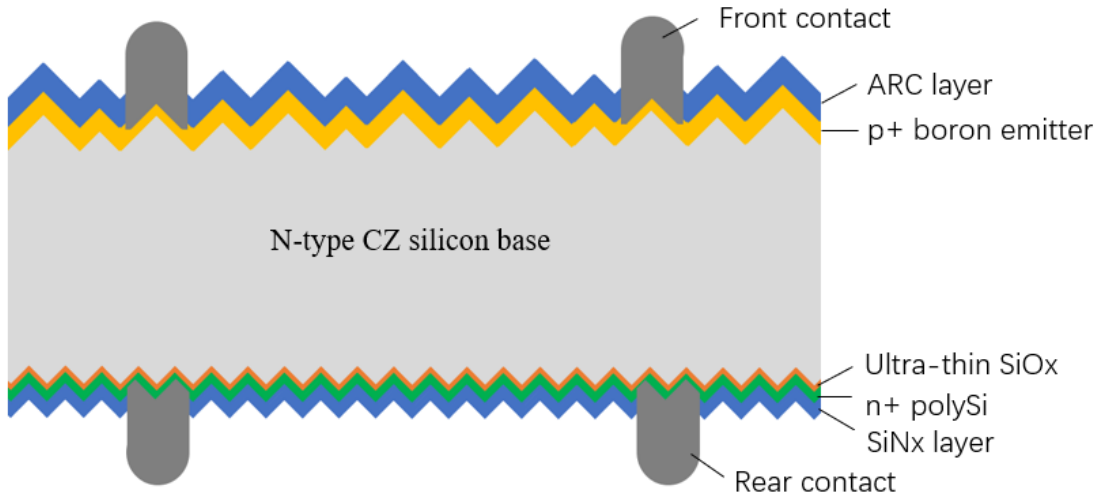
- Voc > 710mV
- Cell Efficiency > 24.5%



TOPCon energy band engineering



HJT energy band engineering



Passivating contact technology

- Excellent passivation performance, J_0 as low as 2 fA/cm²;

Novel metallization system

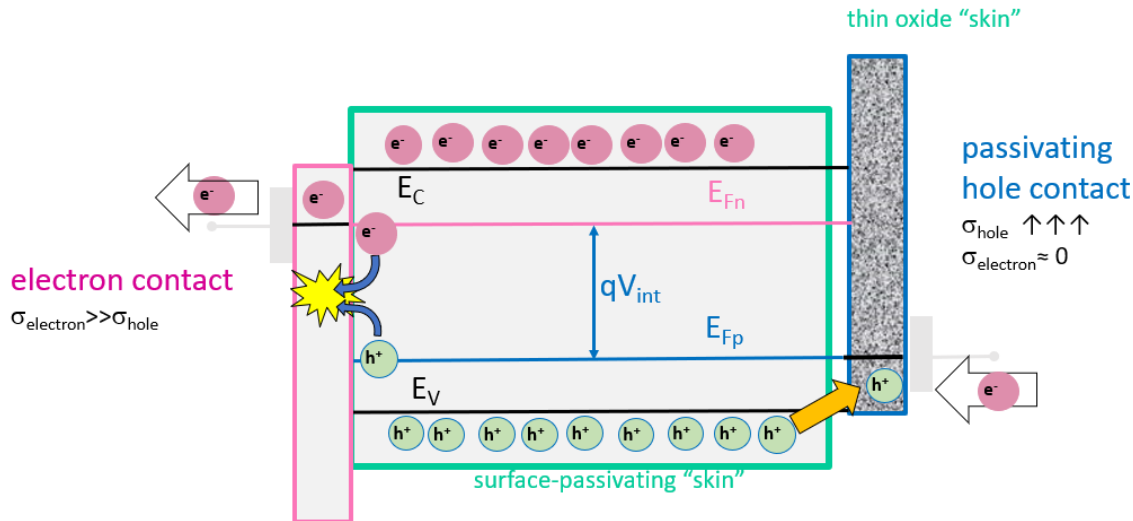
- Semi-isolation between metal and bulk
- Ohmic contact in the poly-region

Optical optimization

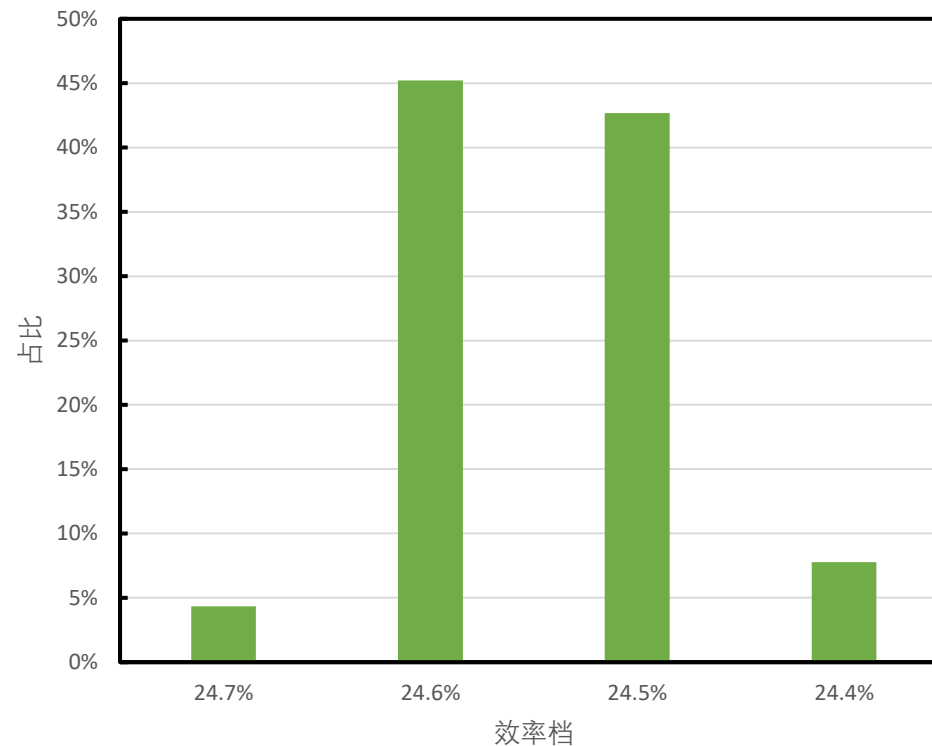
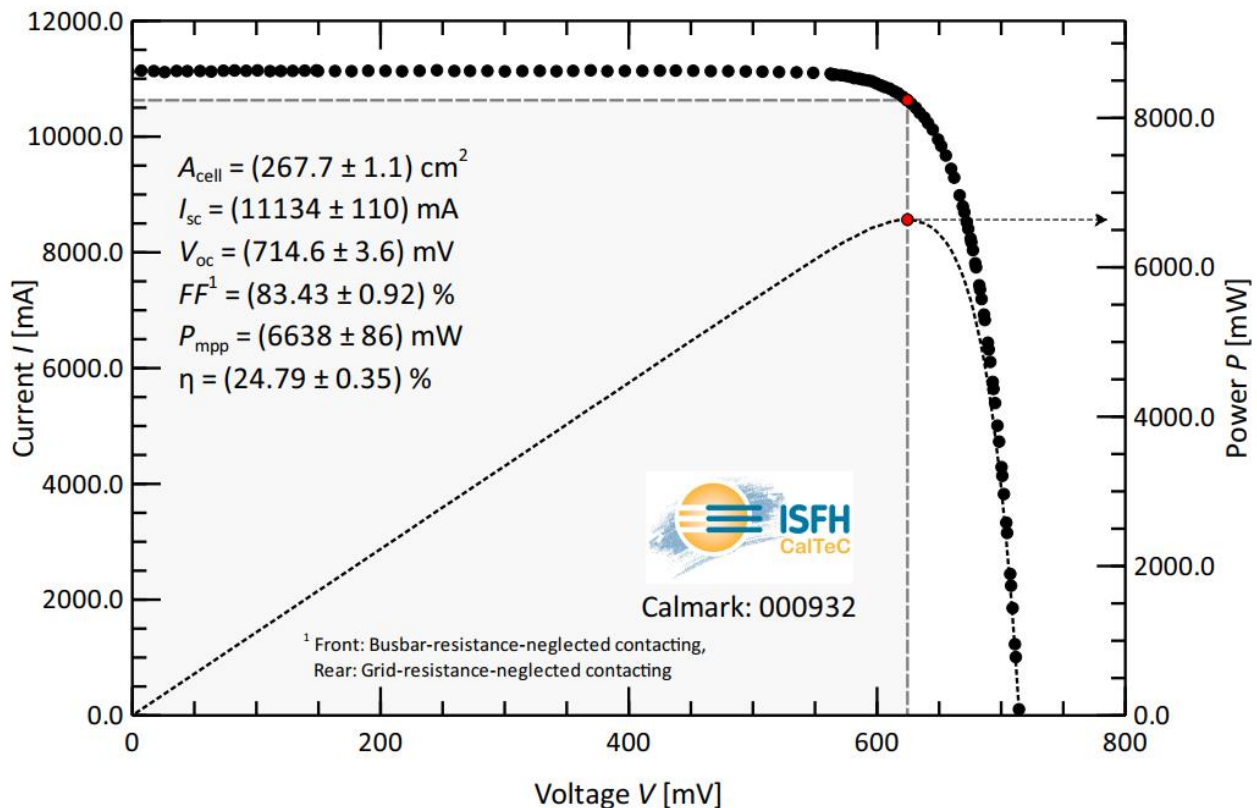
- Front side optical optimisation

Better bulk material

- High lifetime n-type wafers
- No LID degradation



World record mono-Si 24.79%



| Group | Voc (mV) | Isc (A) | FF (%) | Eta (%) | Area (cm ²) |
|---------------|--------------|---------------|--------------|---------------|-------------------------|
| Champion Cell | 714.6 | 11.134 | 83.43 | 24.79 | 267.7 |
| | 714.9 | 11.122 | 83.78 | 24.87% | 267.8 |
| Best Average | 712.7 | 11.125 | 83.10 | 24.61 | 267.7 |

World record mono-Si 24.87%



mono-Si Cell

Device ID: GXb-5

Aug 7, 2020 12:03

Spectrum: ASTM G173 global

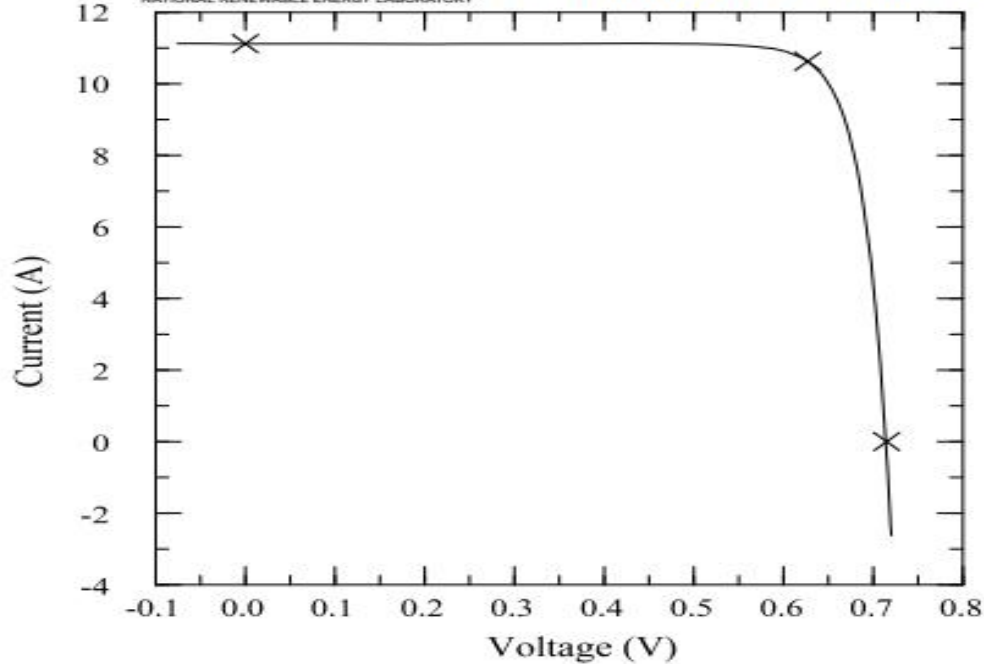
Device Temperature: $24.8 \pm 0.5 \text{ }^\circ\text{C}$

Device Area: $267.8 \text{ cm}^2 \pm 0.1 \%$

Irradiance: 1000.0 W/m^2



X25 IV System
PV Performance Characterization Team



$V_{oc} = 0.7149 \pm 0.0019 \text{ V}$

$I_{sc} = 11.122 \pm 0.090 \text{ A}$

$J_{sc} = 41.54 \pm 0.34 \text{ mA/cm}^2$

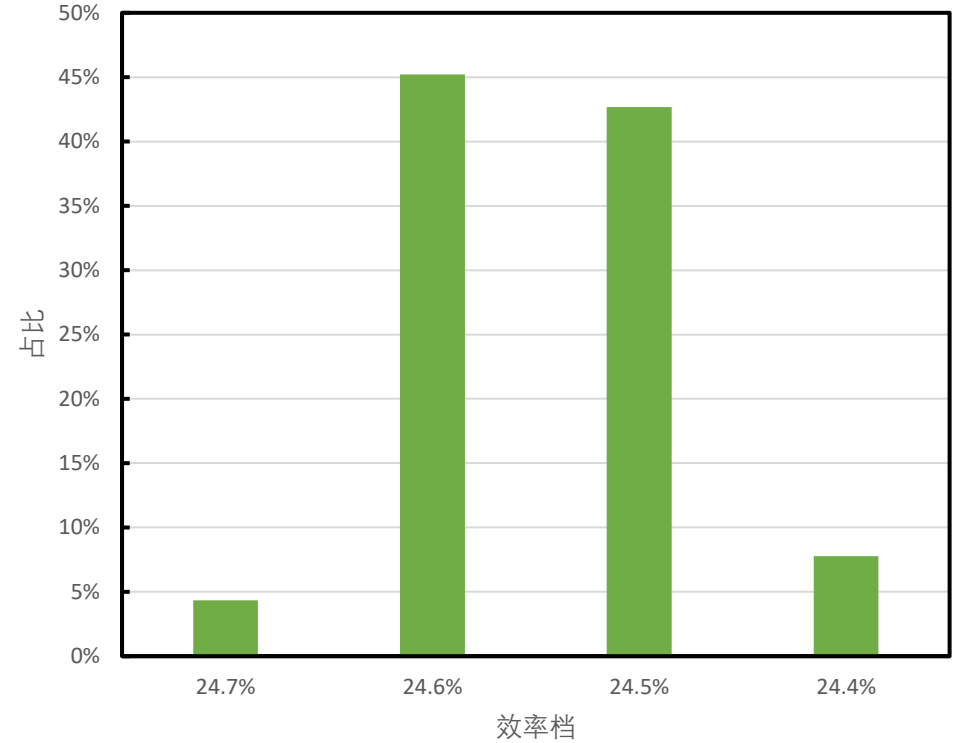
Fill Factor = $(83.78 \pm 0.55) \%$

$I_{max} = 10.627 \pm 0.070 \text{ A}$

$V_{max} = 0.6268 \pm 0.0013 \text{ V}$

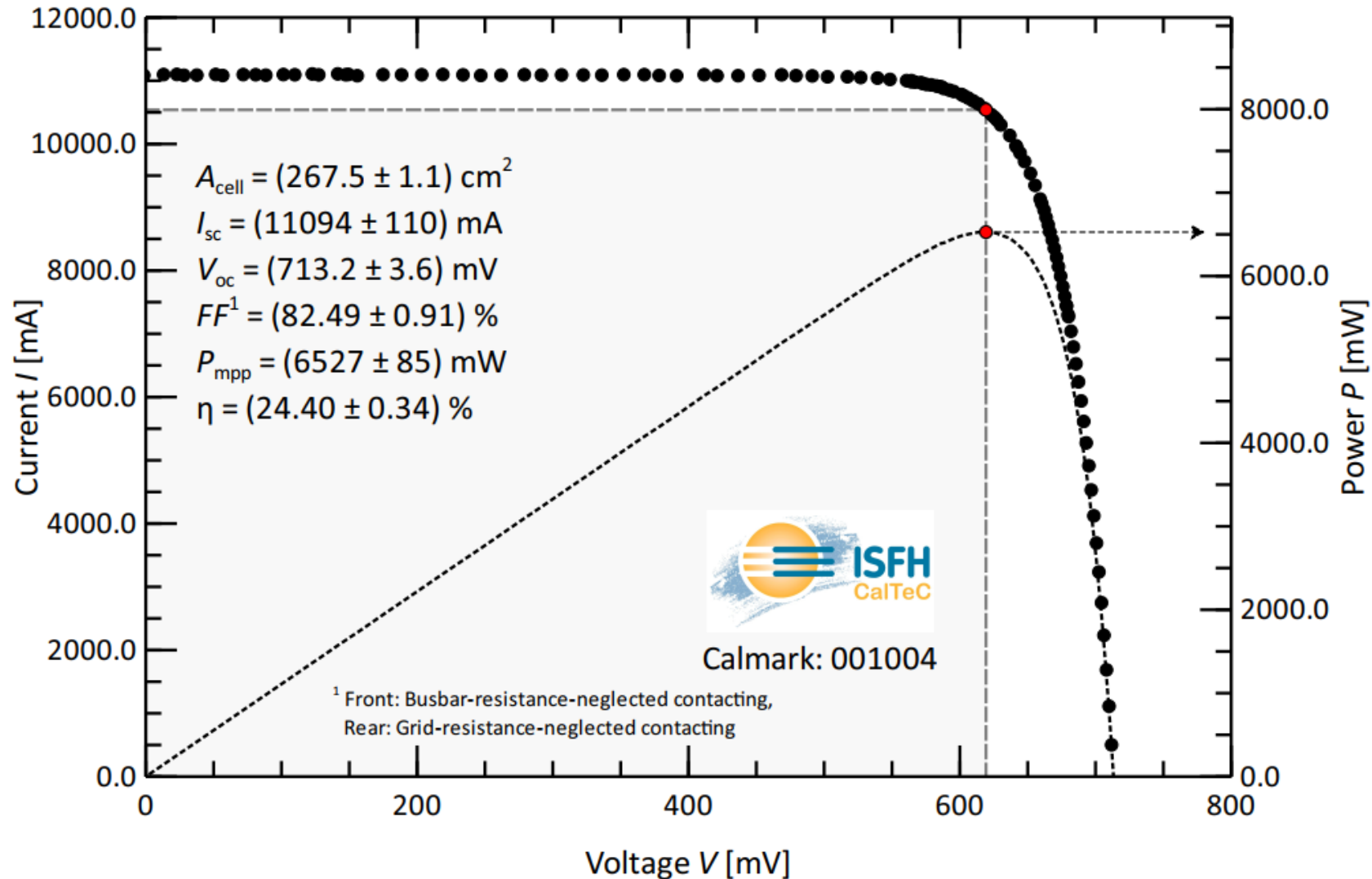
$P_{max} = 6.661 \pm 0.040 \text{ W}$

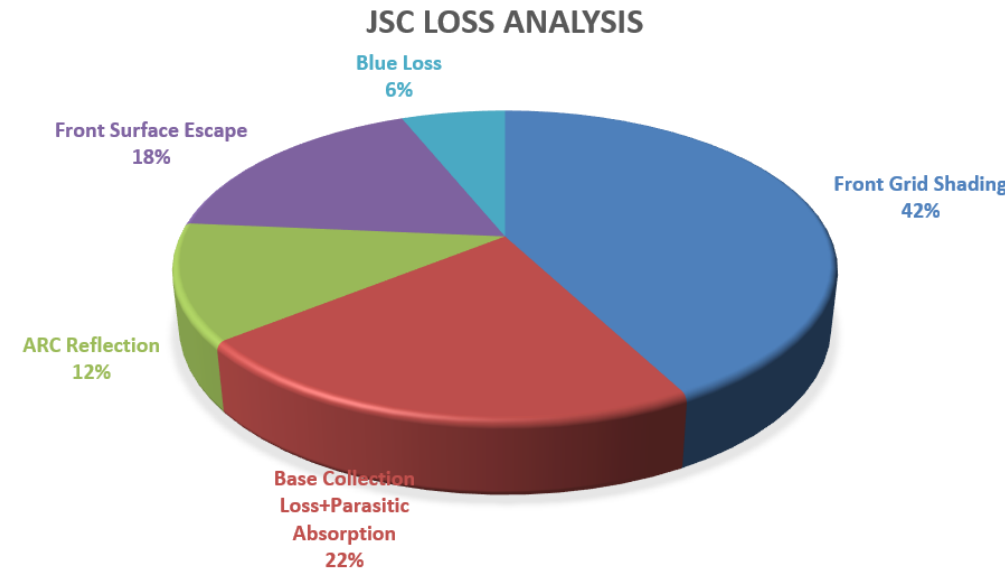
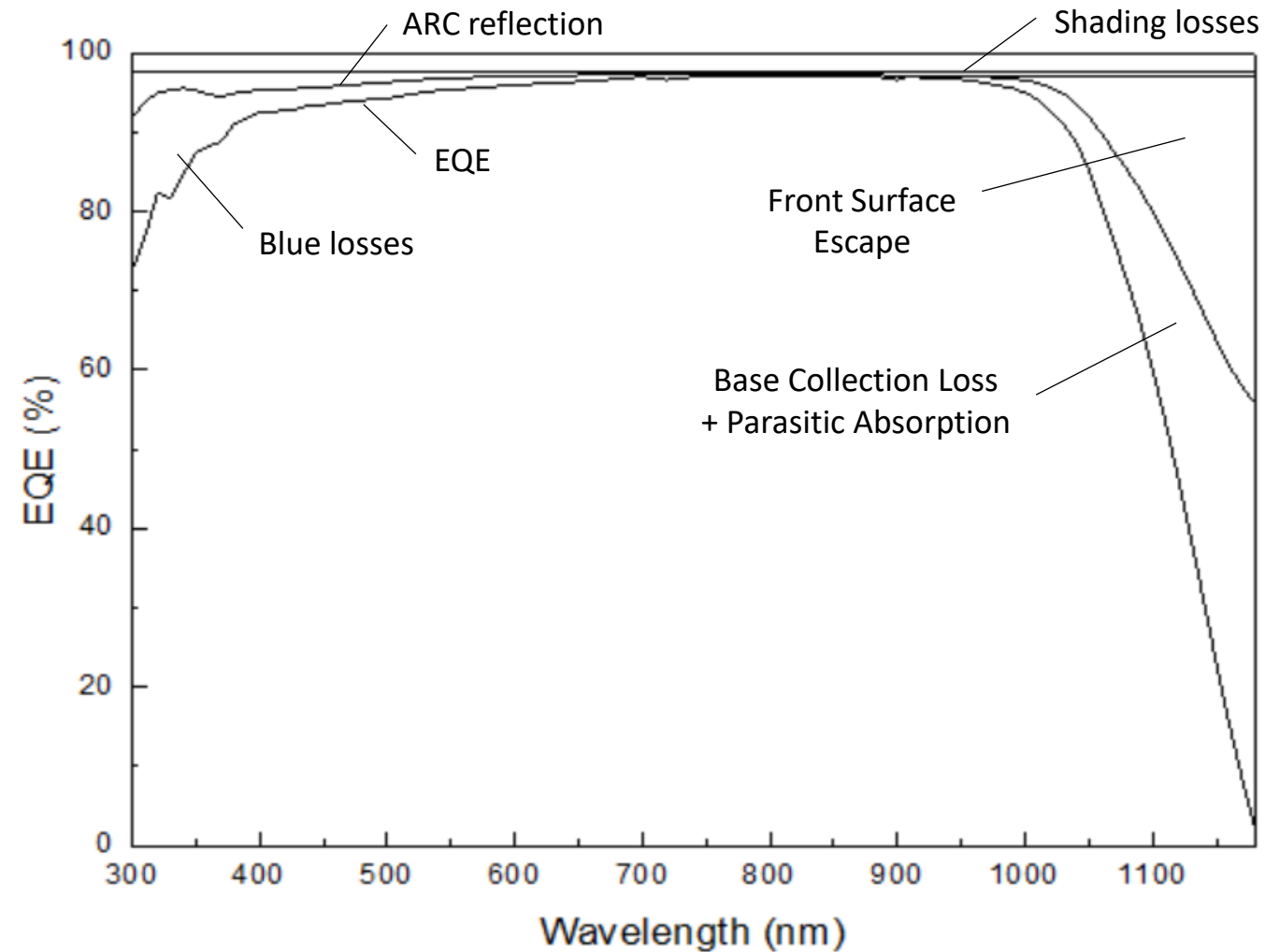
Efficiency = $(24.87 \pm 0.16) \%$



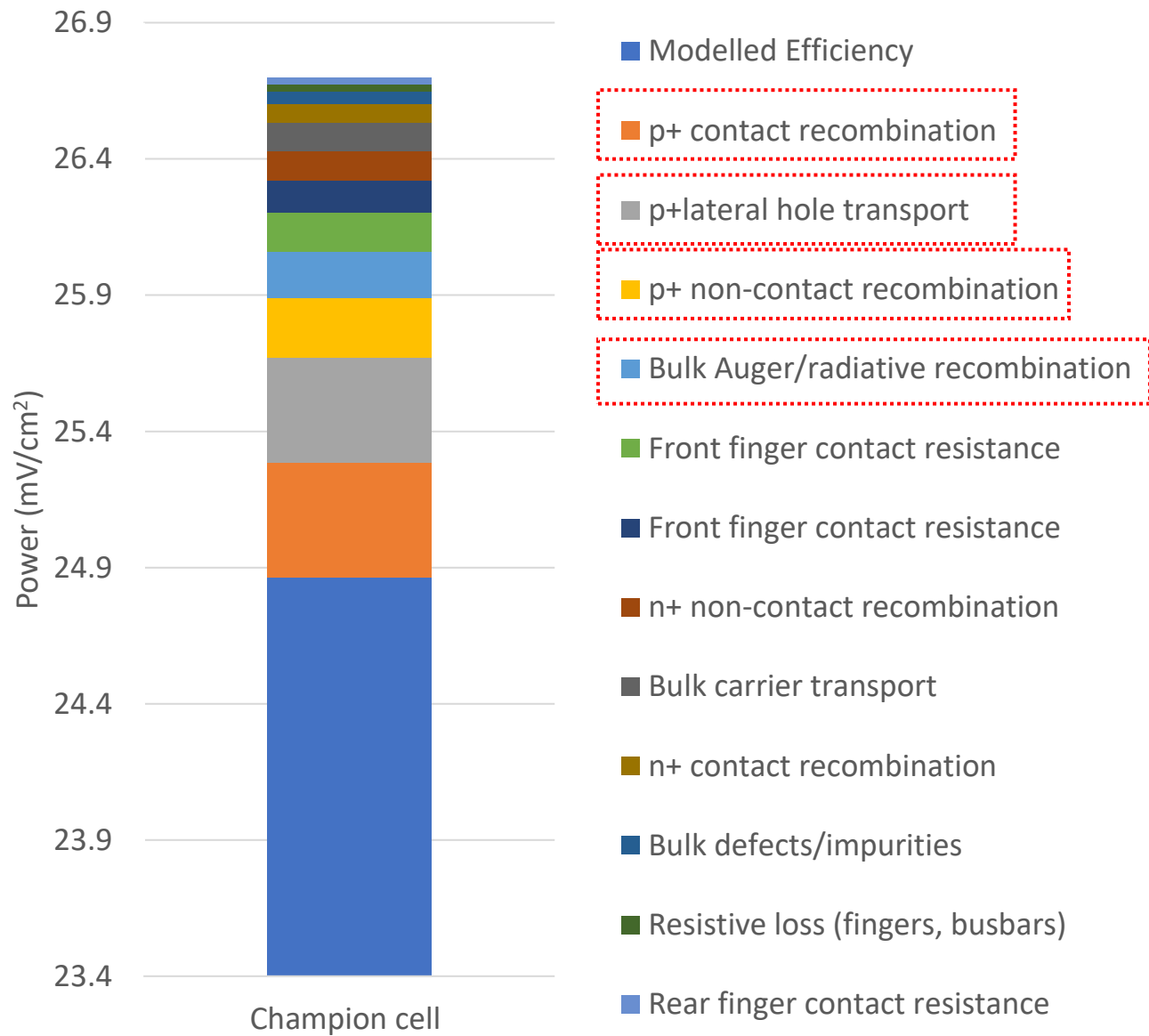
| FF (%) | Eta (%) | Area (cm ²) |
|--------------|---------------|-------------------------|
| 83.43 | 24.79 | 267.7 |
| 83.78 | 24.87% | 267.8 |
| 83.10 | 24.61 | 267.7 |

World record multi-Si 24.40%



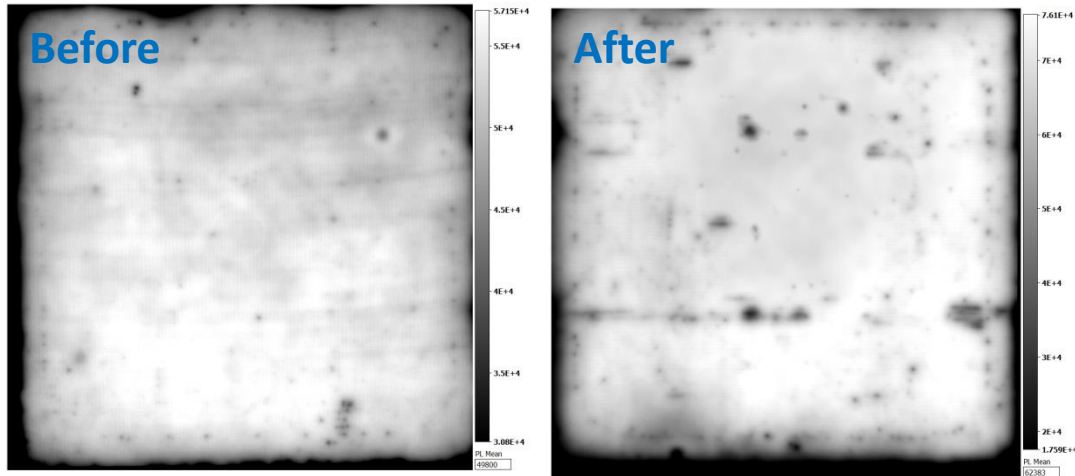


| Jsc Losses | Proportion | Jsc Loss (mA/cm ²) |
|---|------------|--------------------------------|
| Front Grid Shading | 42.28% | 1.04 |
| Base Collection Loss + Parasitic Absorption | 21.95% | 0.54 |
| ARC Reflection | 12.20% | 0.3 |
| Front Surface Escape | 17.48% | 0.43 |
| Blue Loss | 6.10% | 0.15 |
| Total | 100.00% | 2.46 |

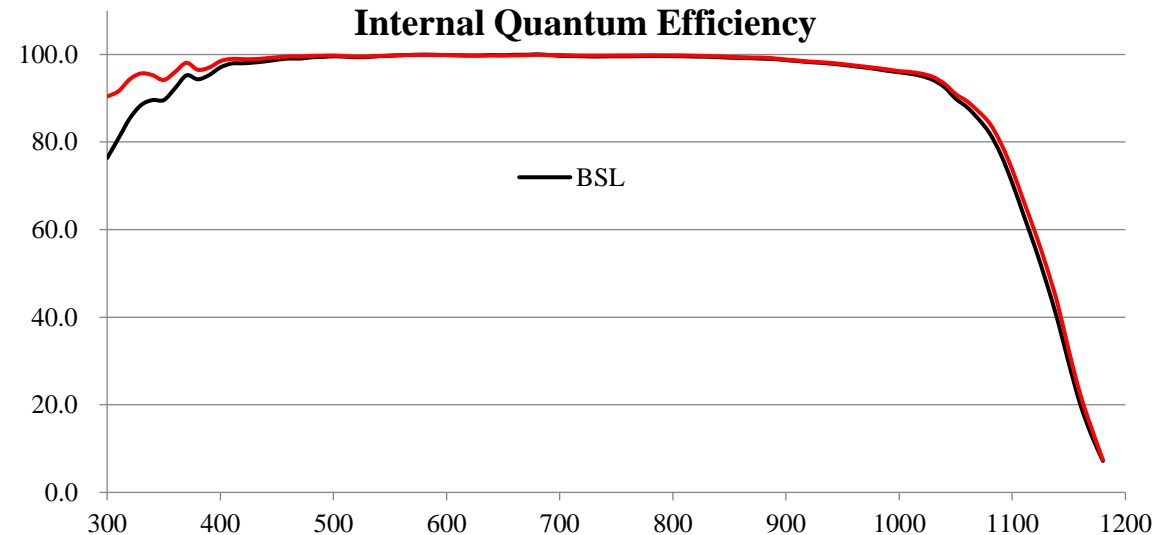


Dopant activation rate improvement

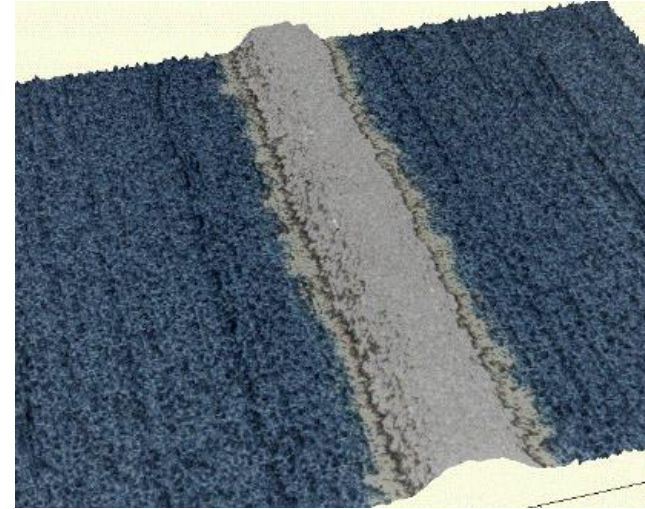
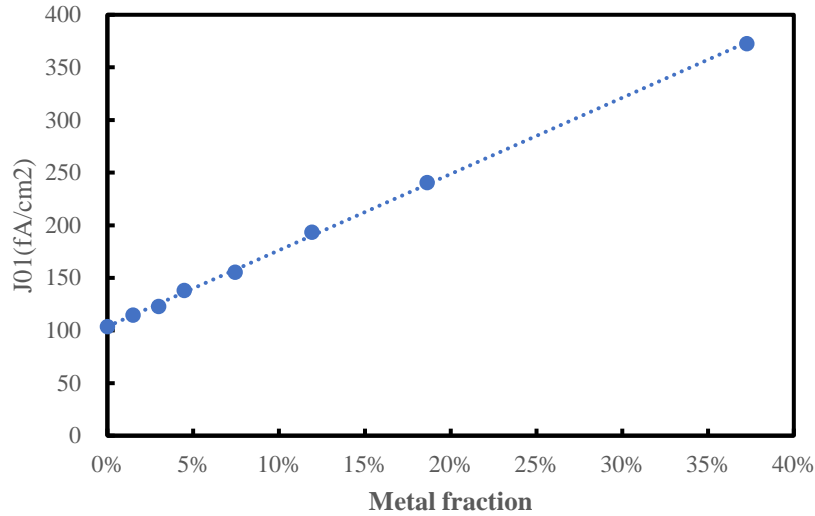
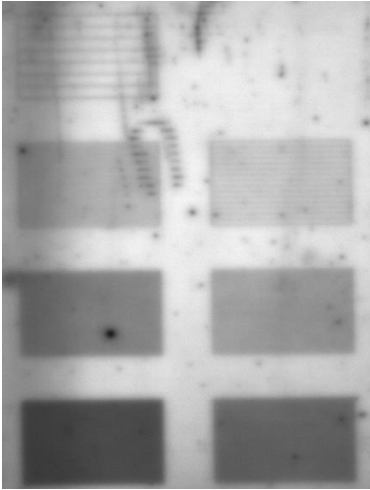
| Dopant | Sheet resistance | Surface doping concentration |
|---------|------------------|---------------------------------------|
| BSL | ~105 ohm/sq | $1.50 \times 10^{19} \text{ cm}^{-3}$ |
| 80% BSL | ~110 ohm/sq | $1.48 \times 10^{19} \text{ cm}^{-3}$ |



➤ PL counts increase >50%

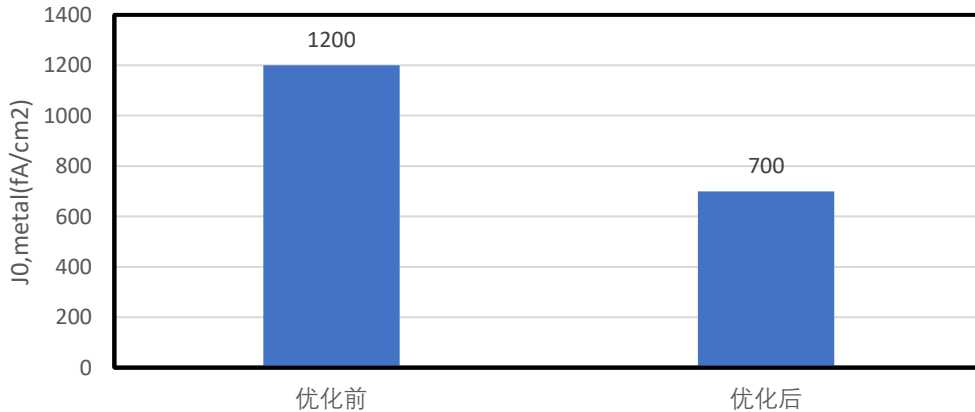


Latest breakthrough – contact system upgrade



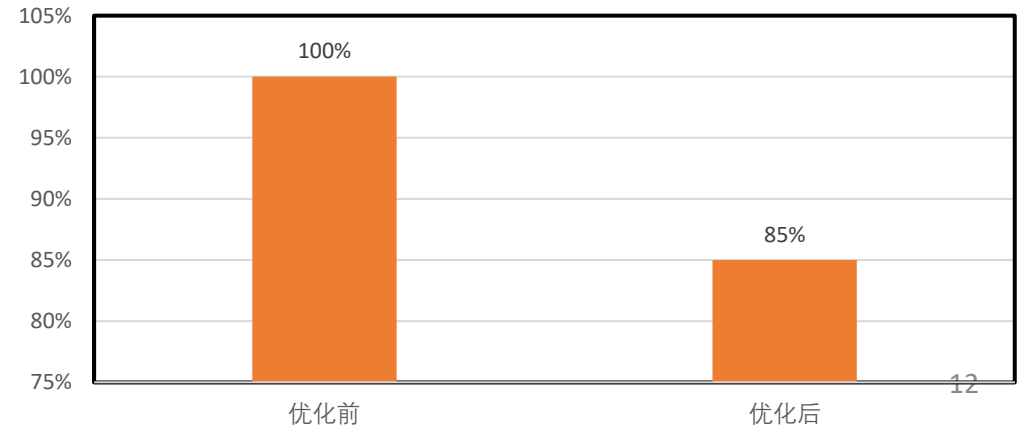
Accurate extraction of $J_{0,metal}$

Recombination reduction at contact region

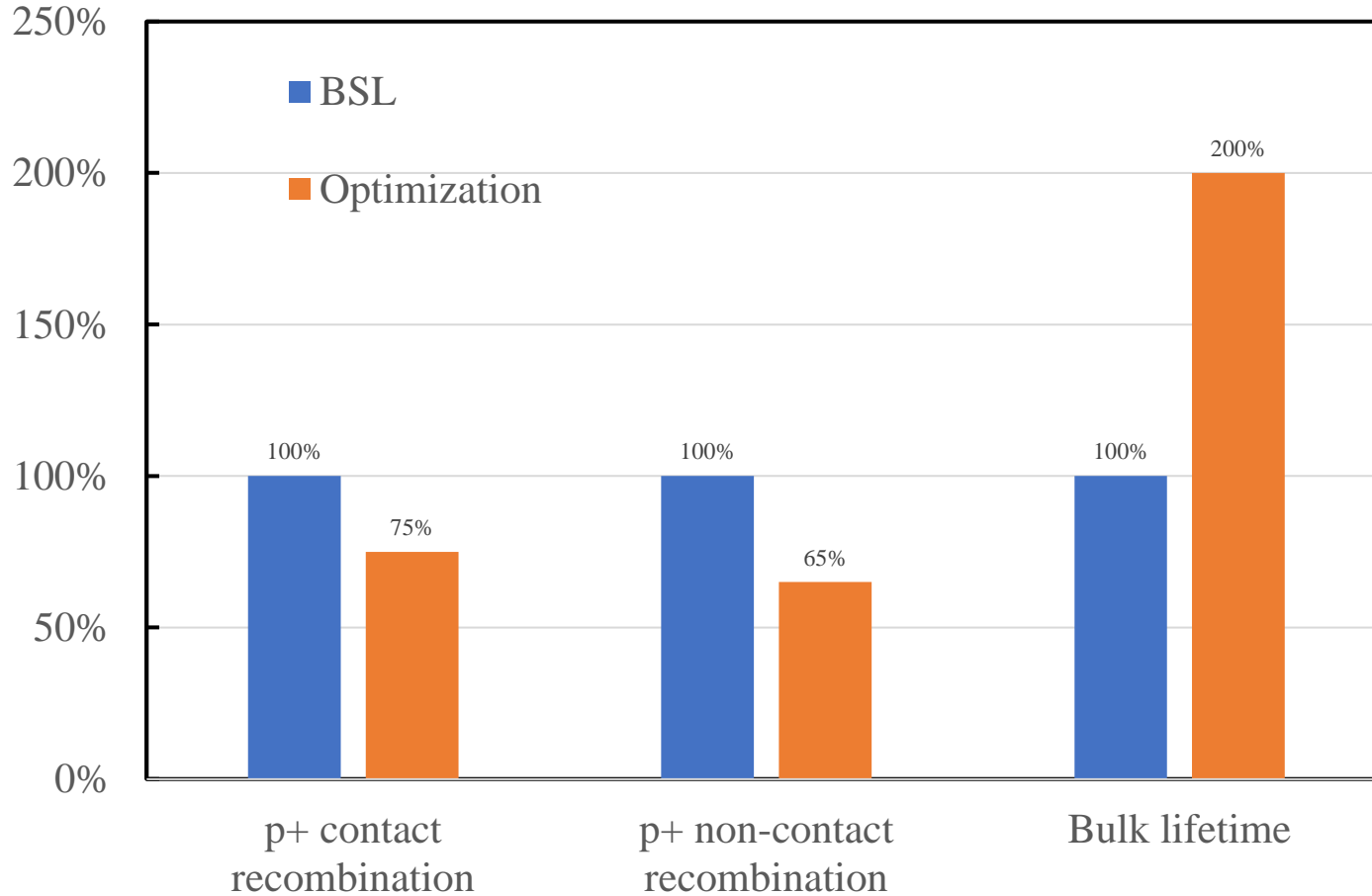


Metal finger width control

Metal finger width reduction



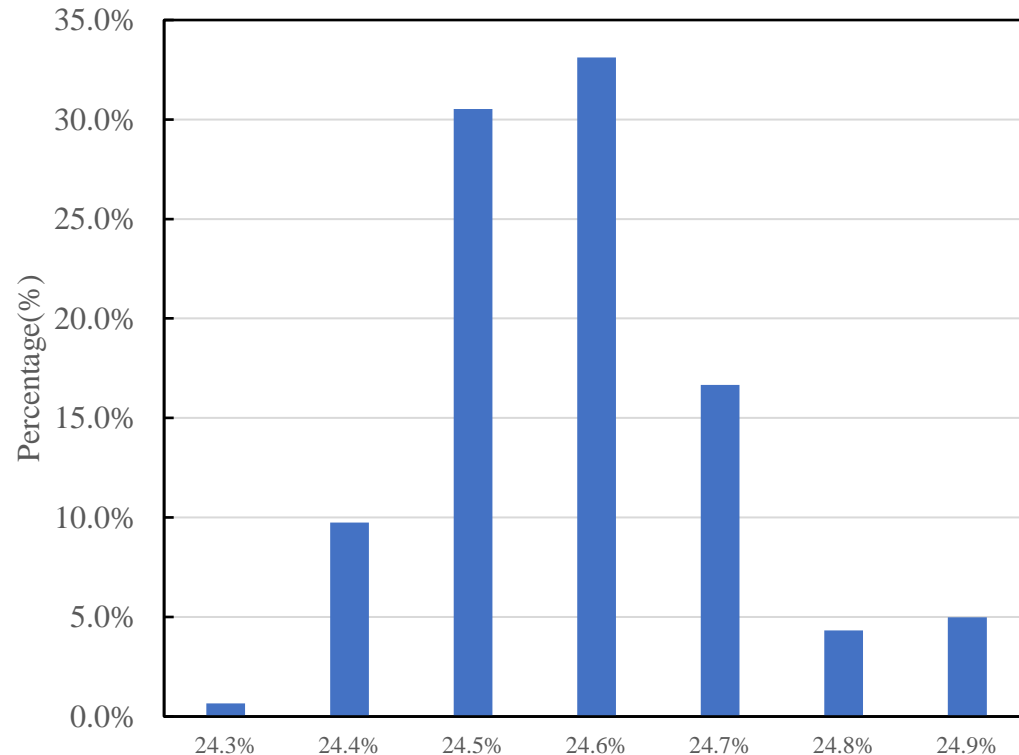
Recombination loss improvement



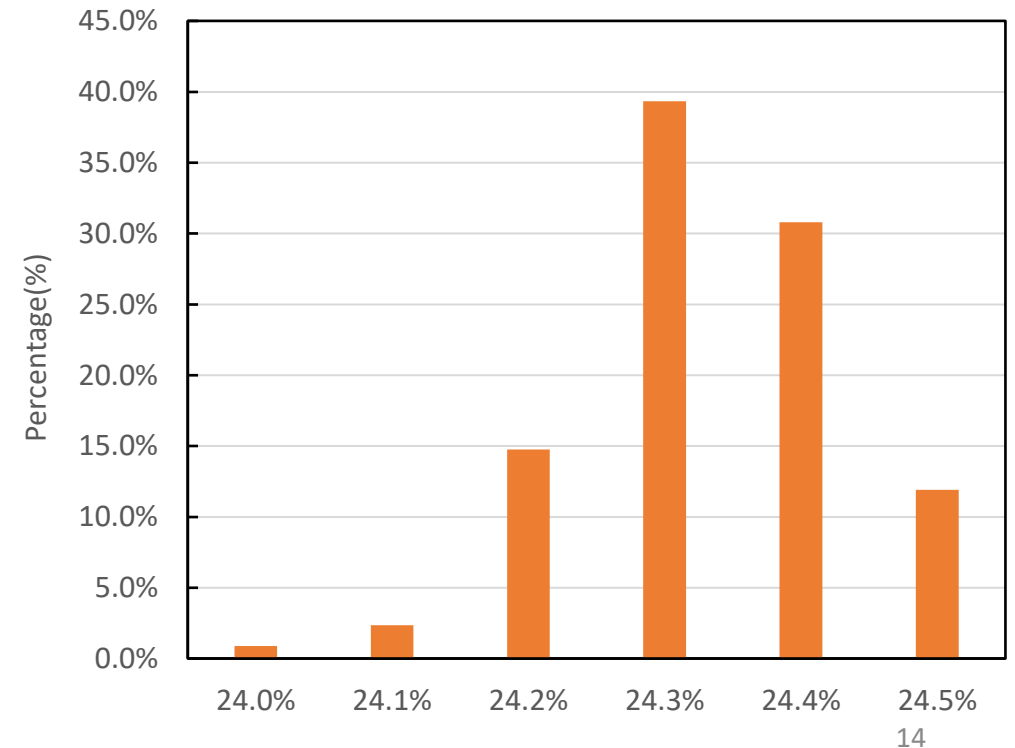
| | Now | Target |
|-----------------|-------|--------|
| Voc (mV) | 716.5 | 719.1 |
| Jsc (%) | 41.54 | 41.60 |
| FF (%) | 83.70 | 83.98 |
| Eta (%) | 24.90 | 25.13 |

- **N型HOT钝化接触电池量产成熟度提升迅速：平均效率，档位分布，良率，成本等**
N-type HOTA technology is developing rapidly at production level: average efficiency, distribution of efficiency, product yield, cost...
- **大面积N型钝化接触电池可量产最高效率预计可以达到25.5%以上；**
N-type HOTA passivated contact cells are expected to achieve efficiency >25.5% for mass production

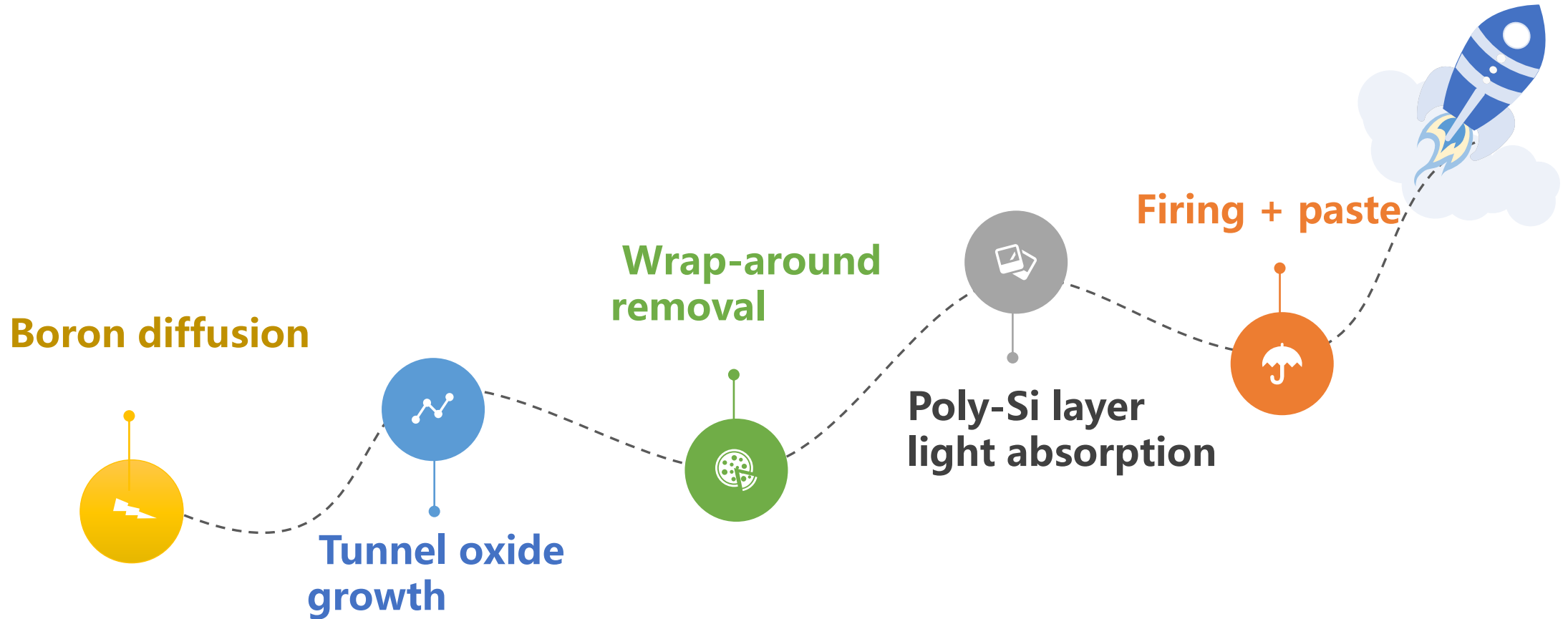
High efficiency batch



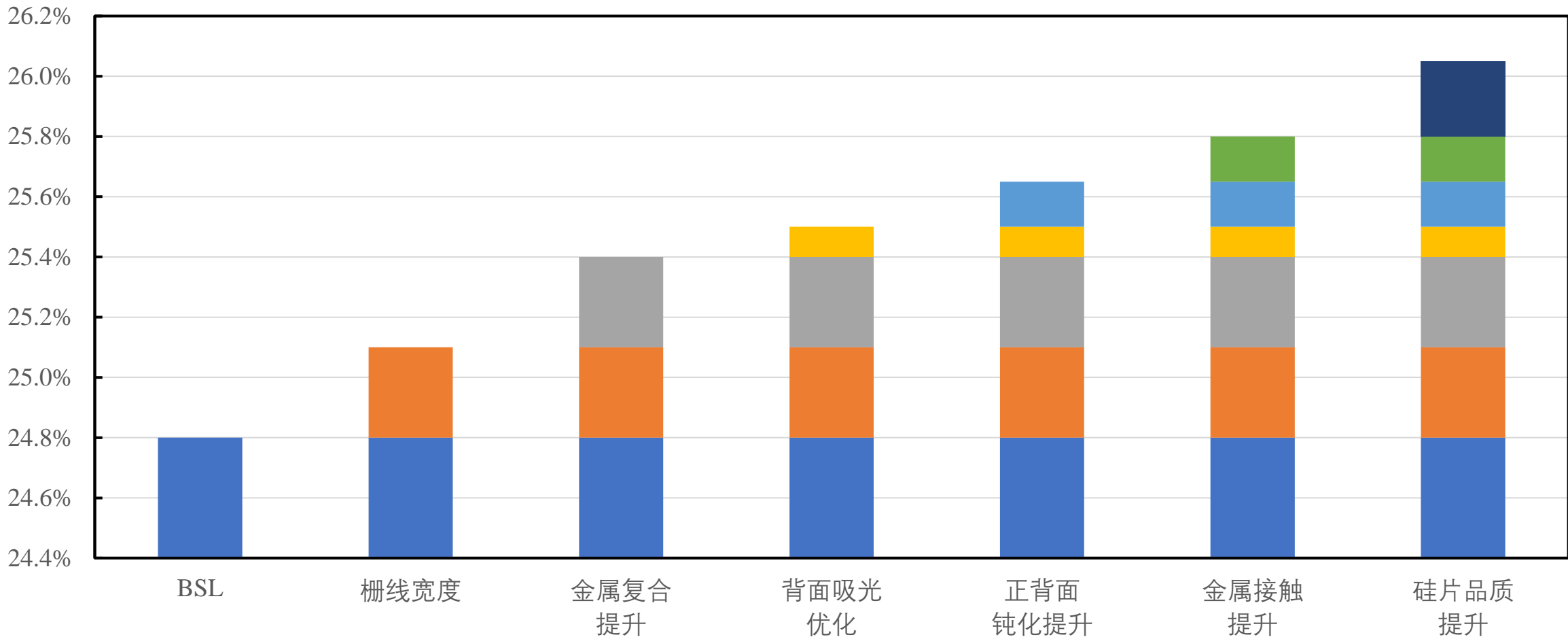
Mass production



Major n-type process challenges overcome



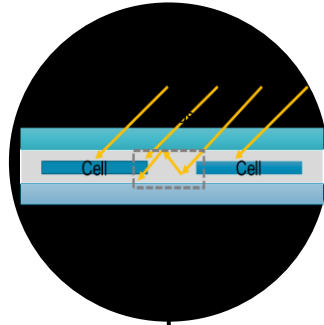
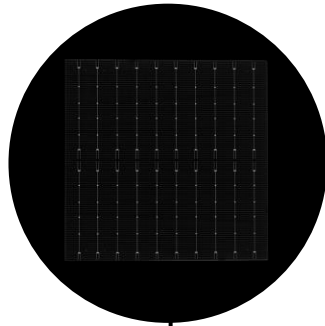
Efficiency roadmap



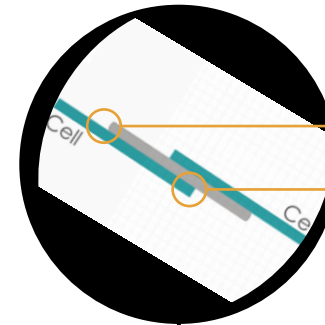
• N型钝化接触电池大面积效率预期可超过26%，量产效率预期可超过25.5%。

Gap reflective coating

MBB

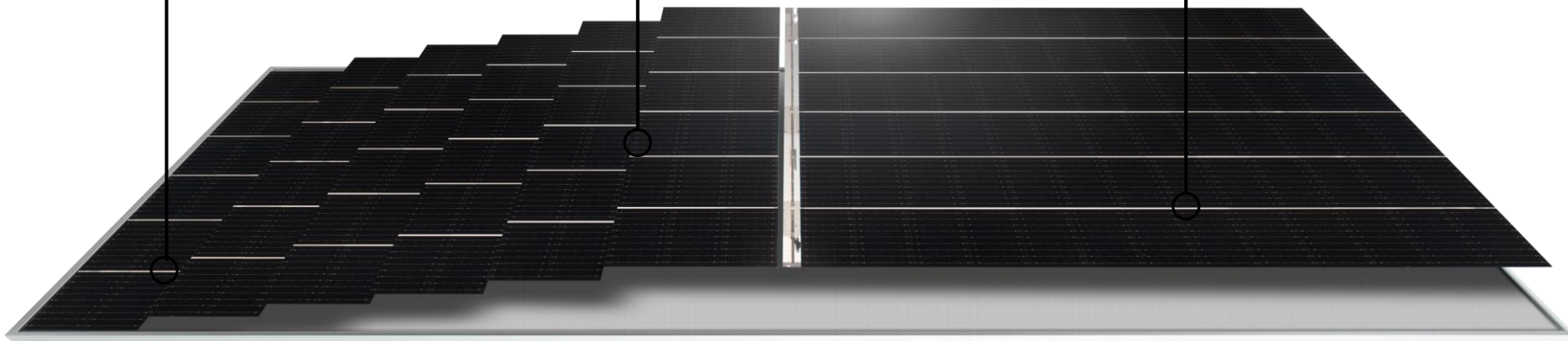


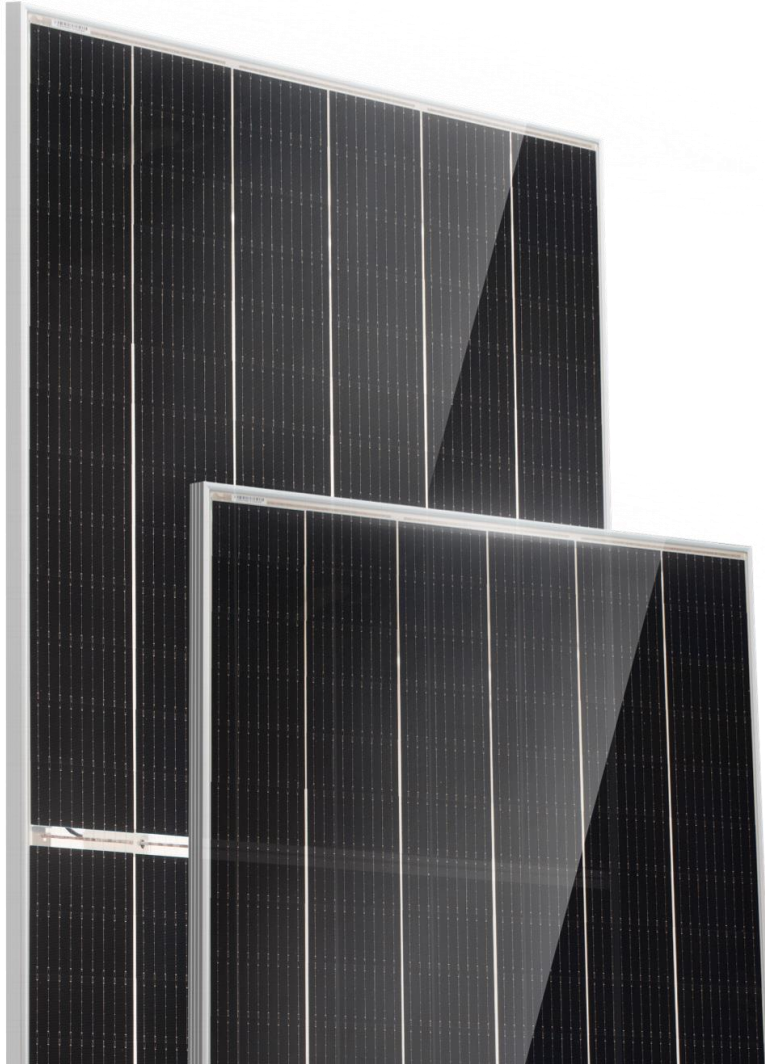
Tiling Ribbon



Soldering wire

No cell gap





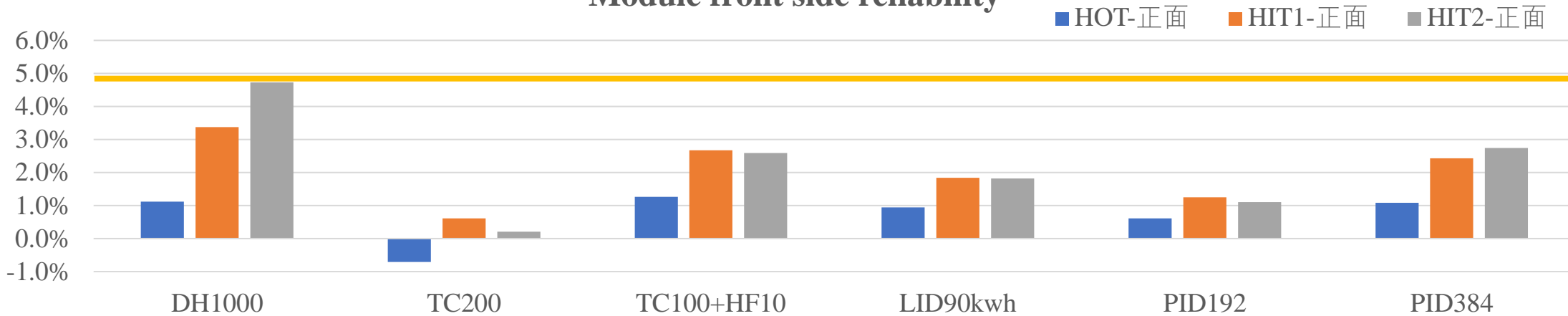
610+W

Module power

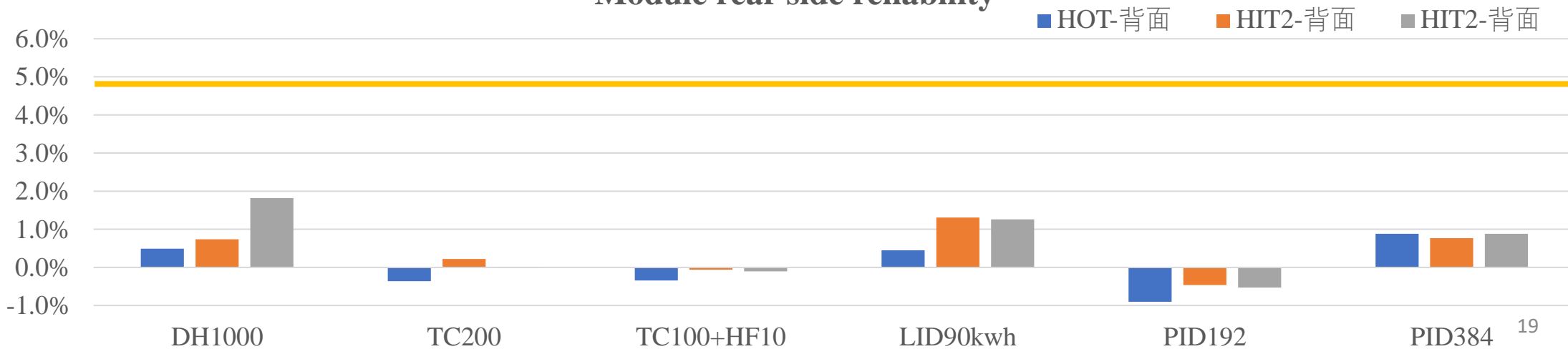
>22%

Module efficiency

Module front side reliability



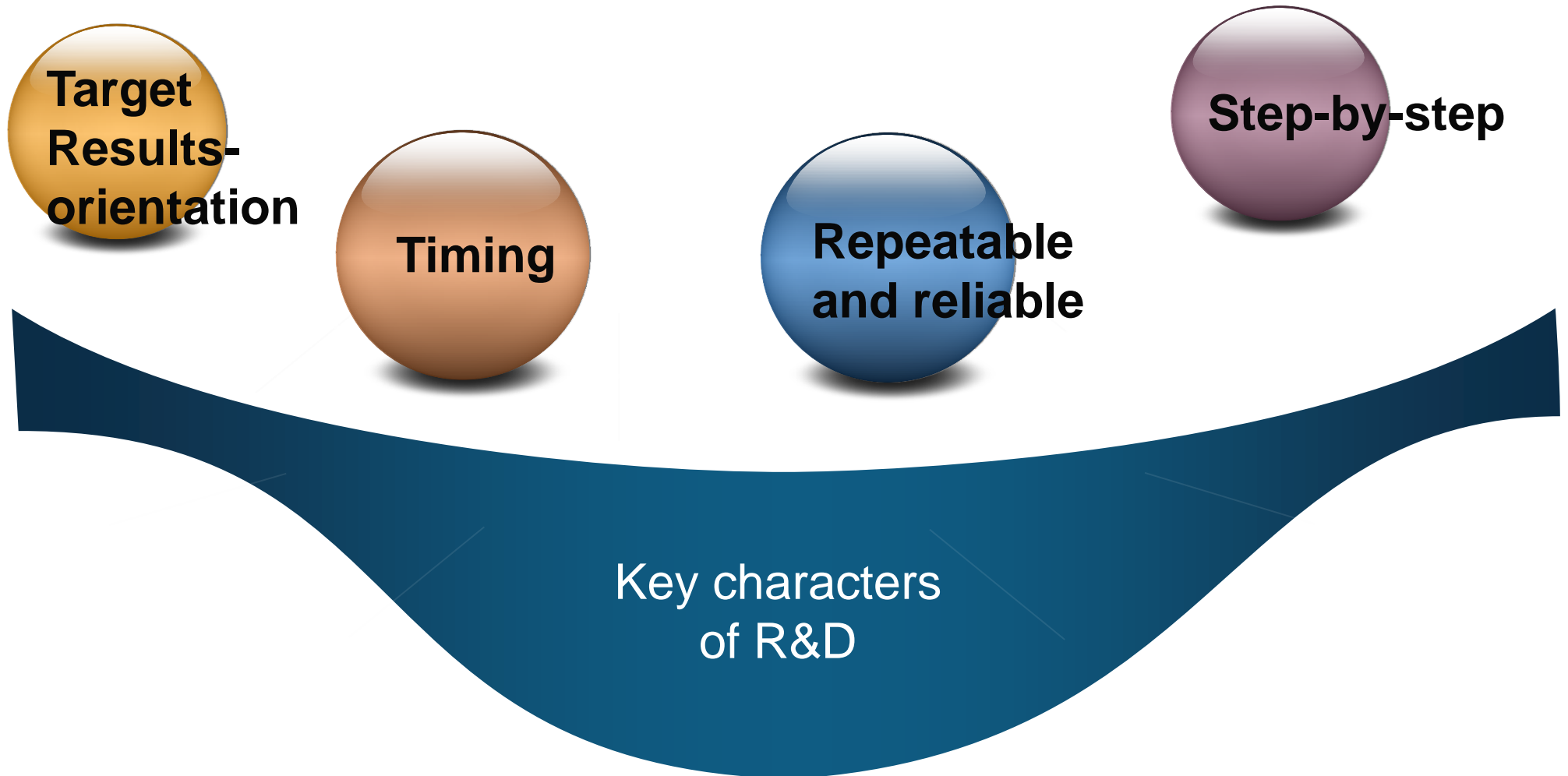
Module rear side reliability



n-TOPCon research at Jinko Solar

Discussion about industrial innovation work

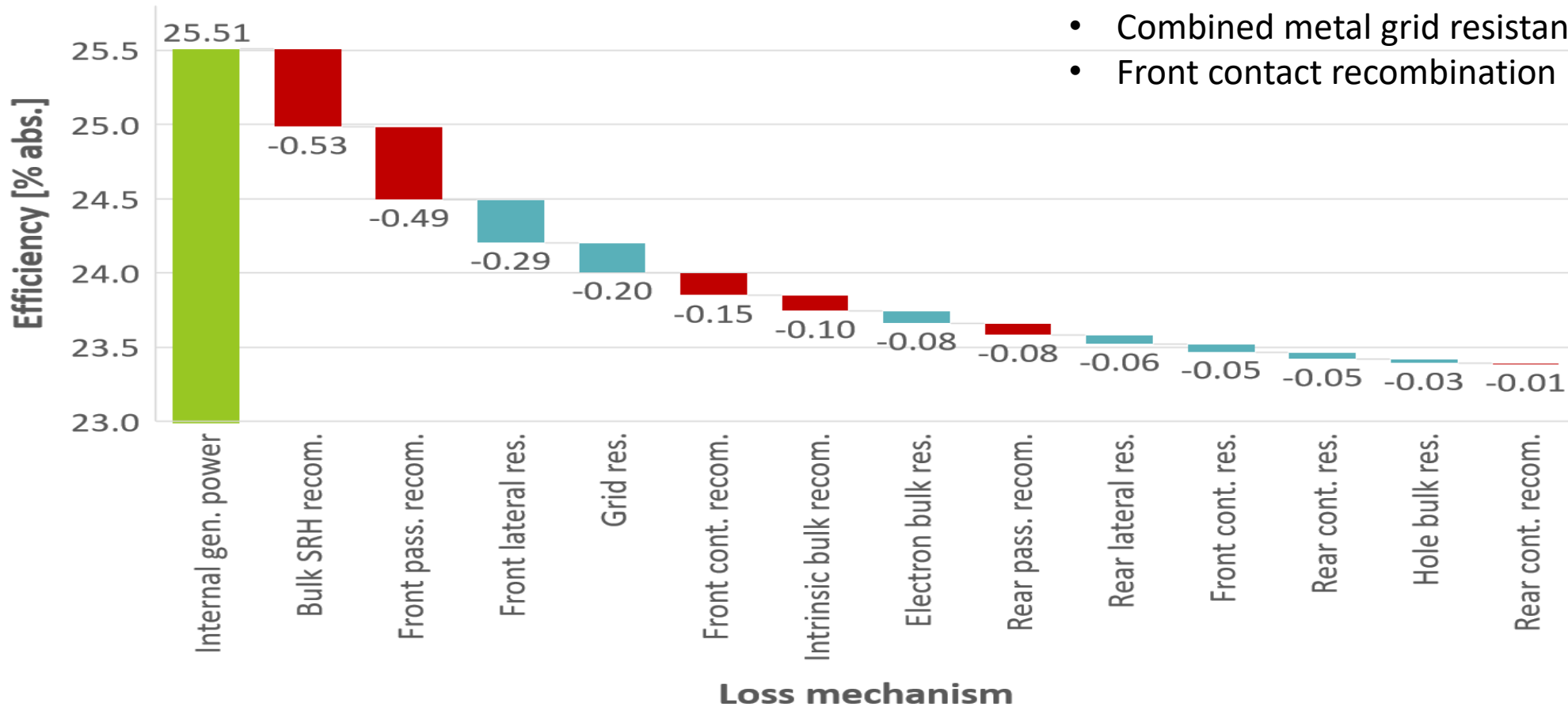
Hot topics in PV industry (questions welcome)



Big changes come from very detailed analysis and continuous observation

Main electrical losses:

- Bulk lifetime
- Front surface passivation
- Emitter sheet resistance
- Combined metal grid resistance
- Front contact recombination



Do not be afraid to be the first one

Do not insist secondary deductions

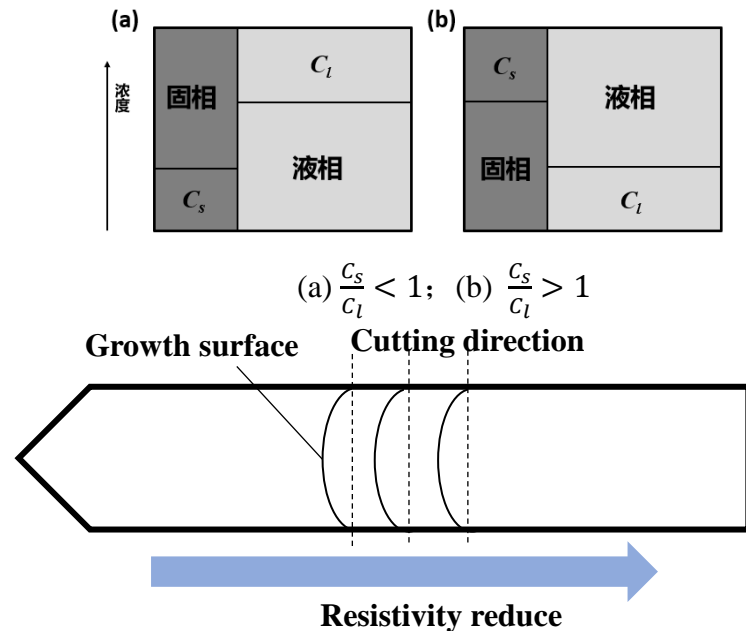
Theories vs practical finding

Due to the separation coefficient (k) change for dopants: $B > P > Ga$

N-type wafer's relative cost is reducing comparing to p-type wafers.

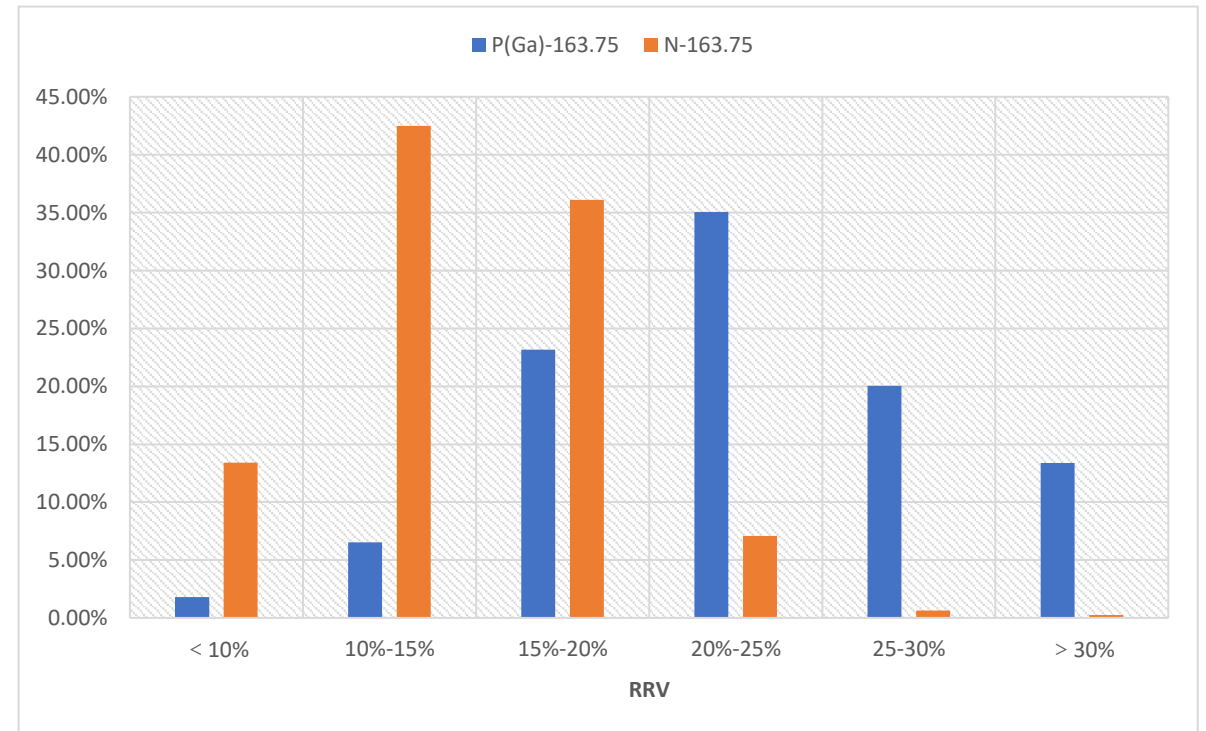
$$k = \frac{C_s}{C_l}$$

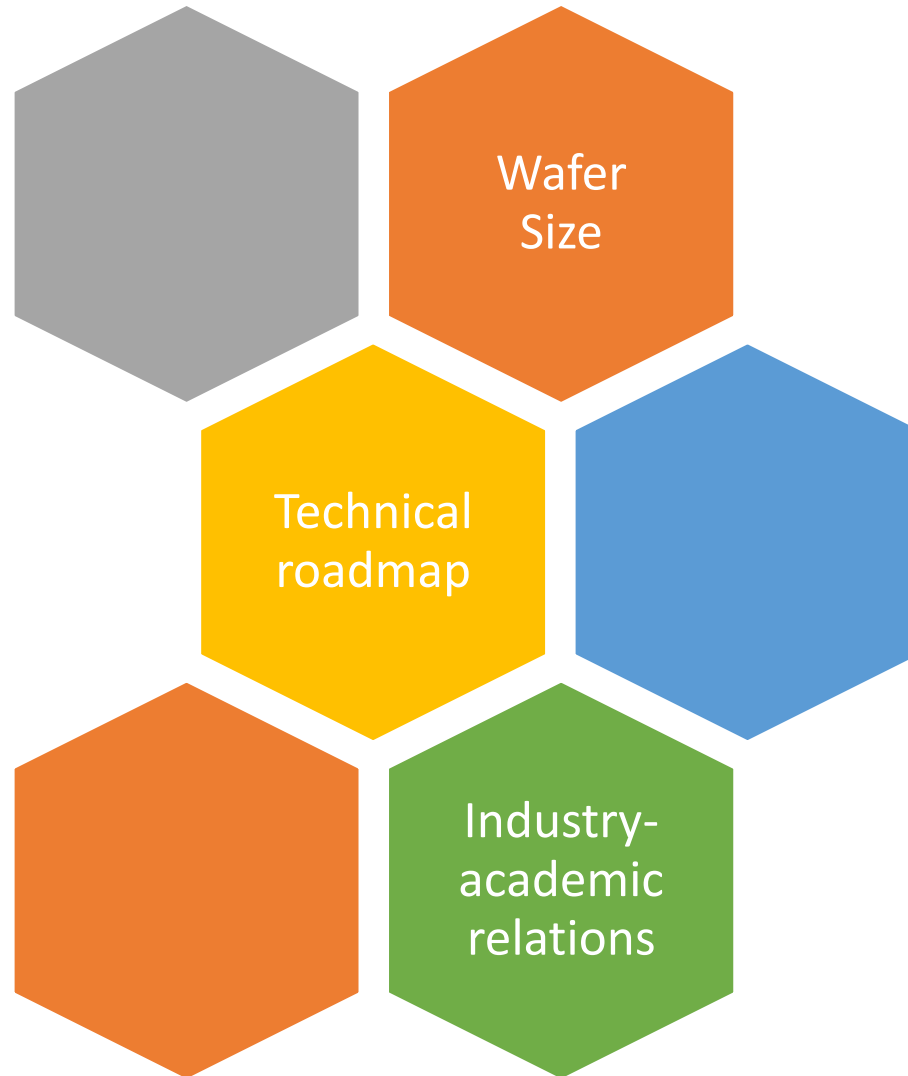
Dopant concentration in ingot
Dopant concentration in liquid Si



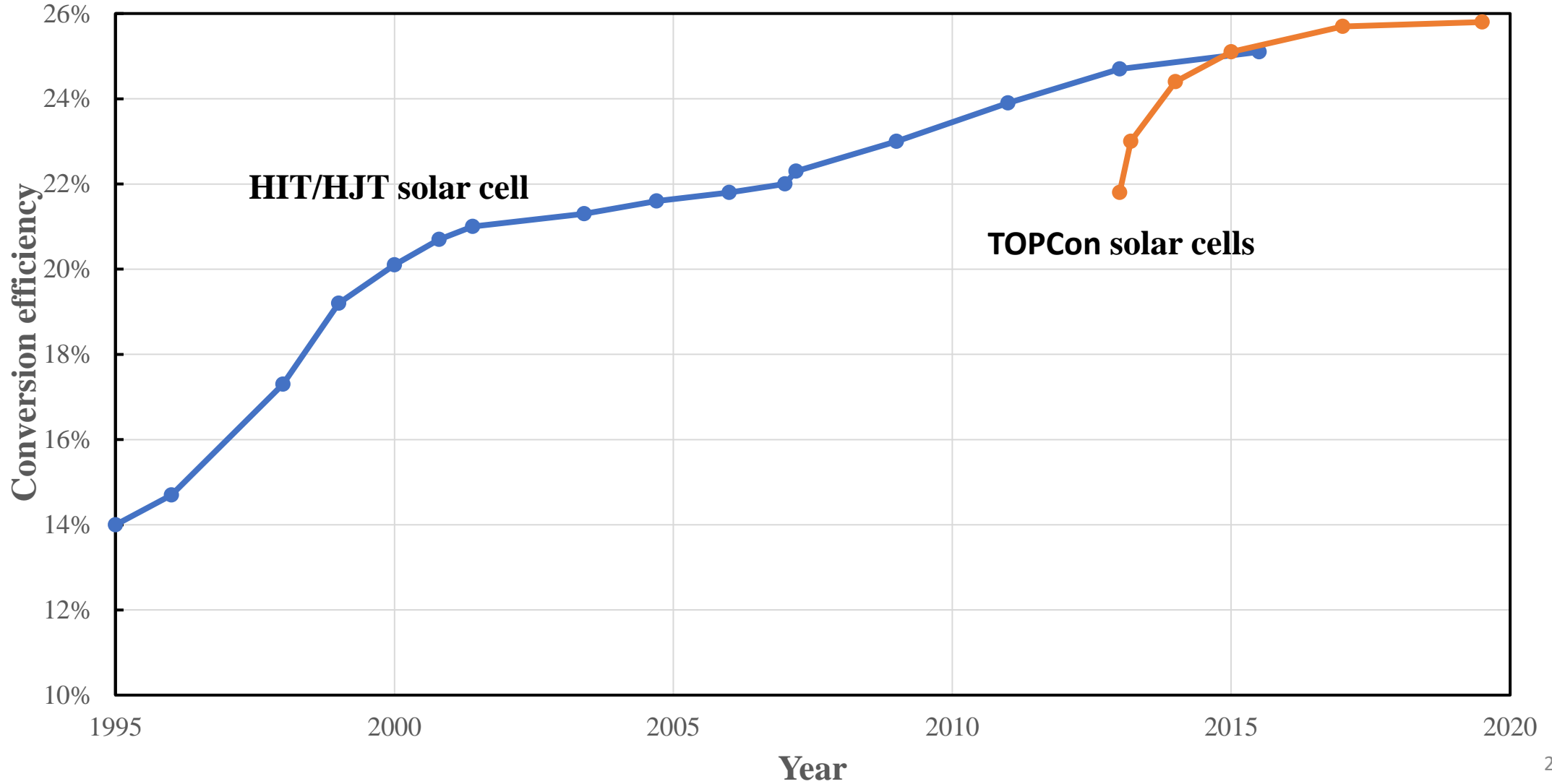
N-type wafers become “large-size” friendly

RRV performance of different wafers





TOPCon vs HJT



Thanks !

